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Electronic Patent Application Submission

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Application ID: 10706468



Title of Invention: SEMICONDUCTOR PACKAGE
WITH CHAMFERED CORNERS
AND METHOD OF
MANUFACTURING THE SAME

First Named Inventor: Sung Yang

Domestic/Foreign Application: Domestic Application

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Statement

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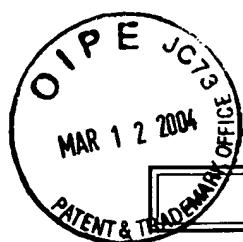
Confirmation number: 6744

Attorney Docket Number: AMKOR095A

Total Fees Authorized:

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TRANSMITTAL

Electronic Version v1.1
Stylesheet Version v1.1.0

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Date:	2003-11-12	
First Named Applicant:	Sung Jin Yang	
Confirmation Number:	6744	
Attorney Docket Number:	AMKOR095A	
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Submitted by:	Elec. Sign.	Sign. Capacity
Mark B. Garred Registered Number: 34,823	/mbg/	Attorney
Documents being submitted us-ids	Files ids4-usidst.xml us-ids.dtd us-ids.xsl	
Comments		



ELECTRONIC INFORMATION DISCLOSURE STATEMENT

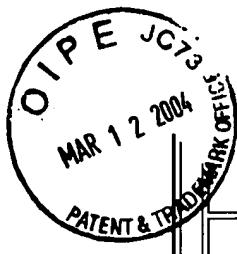
Electronic Version v18
Stylesheet Version v18.0

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Application Number:	10/706468
Confirmation Number:	6744
First Named Applicant:	Sung Yang
Attorney Docket Number:	AMKOR095A
Art Unit:	2811
Search string:	(5903049 or 5909053 or 5917242 or 5915998 or 5939779 or 5942794 or 5951305 or 5959356 or 5969426 or 5973388 or 5977630 or 5977615 or 5977613 or 5976912 or 5981314 or 5986885 or 5986333 or 6001671 or 6013947 or 6018189 or 6020625 or 6025640 or 6031279 or 6034423 or RE36613 or 6040626 or 6043430 or 6060769 or 6060768 or 6072228 or 6075284 or 6081029 or 6084310 or 6087722 or 6087715 or 6100594 or 6113474 or 6118184 or 6118174 or RE36907 or 6130473 or 6130115 or 6133623 or 6140154 or 6143981 or 6169329 or 6177718 or 6181002 or 6184573 or 6184465).pn.

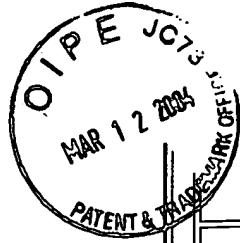
US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
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	2	5909053	1999-06-01	FUKASE ET AL.			
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Signature

Examiner Name	Date